

## PATENT ASSIGNMENT COVER SHEET

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
NICOLAAS W VANVONNO	06/24/2004
DUSTIN WOODBURY	06/24/2004
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<b>Property Type</b>	<b>Number</b>
Patent Number:	7187056
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<b>DATE SIGNED:</b>	10/21/2015
<b>Total Attachments: 1</b>	
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**ASSIGNMENT  
WORLD WIDE PATENT RIGHTS**

For good and valuable consideration, the sufficiency and receipt of which is hereby acknowledged, as a below named inventor, I hereby sell and assign to Intersil Americas Inc. (hereinafter called ASSIGNEE), a Delaware corporation of 675 Trade Zone Boulevard, Milpitas, California 95035, its successors and assigns or other legal representatives all my rights, title and interest, in and for the United States of America and all foreign countries, in and to the invention entitled:

**RADIATION HARDENED BIPOLAR JUNCTION TRANSISTOR**

the specification of which is filed herein and was invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, and all United States Letters Patent which may be granted therefor, and all divisions, continuations, and extensions thereof, the said interest being the entire ownership of the said Letters Patent and any foreign Letters Patent when granted, to be held and enjoyed by said ASSIGNEE, its successors, assigns or other legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said ASSIGNEE;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said ASSIGNEE.

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24 June 2004  
(Date)

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